## 2SK4206G

## Silicon N-channel junction FET

For impedance conversion in low frequency
For electret capacitor microphone

## Features

- Low noise voltage NV
- High voltage gain GV
- Thin package: TSSSMini3-F2 $(1.2 \mathrm{~mm} \times 1.2 \mathrm{~mm} \times 0.33 \mathrm{~mm})$
- Absolute Maximum Ratings $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$

| Parameter | Symbol | Rating | Unit |
| :--- | :---: | :---: | :---: |
| Drain-source voltage (Gate open) | $\mathrm{V}_{\text {DSO }}$ | 20 | V |
| Drain-gate voltage (Souece open) | $\mathrm{V}_{\text {DGO }}$ | 20 | V |
| Drain-source current (Gate open) | $\mathrm{I}_{\text {DSO }}$ | 2 | mA |
| Drain-gate current (Souece open) | $\mathrm{I}_{\text {DGO }}$ | 2 | mA |
| Power dissipation | $\mathrm{P}_{\mathrm{D}}$ | 100 | mW |
| Operating ambient temperature | $\mathrm{T}_{\text {opr }}$ | -20 to +80 | ${ }^{\circ} \mathrm{C}$ |
| Storage temperature | $\mathrm{T}_{\text {stg }}$ | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |

Electrical Characteristics $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C} \pm 3^{\circ} \mathrm{C}$

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Drain current ${ }^{* 1}$ | $\mathrm{I}_{\mathrm{D}}$ | $\mathrm{V}_{\mathrm{DS}}=2.0 \mathrm{~V}, \mathrm{R}_{\mathrm{d}}=2.2 \mathrm{k} \Omega \pm 1 \%$ | 170 |  | 470 | $\mu \mathrm{A}$ |
| Drain-source current *2 | $\mathrm{I}_{\mathrm{DSS}}$ | $\mathrm{V}_{\mathrm{DS}}=2.0 \mathrm{~V}, \mathrm{R}_{\mathrm{d}}=2.2 \mathrm{k} \Omega \pm 1 \%, \mathrm{~V}_{\mathrm{GS}}=0$ | 180 | C) | 450 | $\mu \mathrm{A}$ |
| Forward transfer conductance | $\left\|\mathrm{Y}_{\mathrm{fs}}\right\|$ | $\mathrm{V}_{\mathrm{D}}=2.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{GS}}=0, \mathrm{f}=1 \mathrm{kHz}$ | 660 | 1500 |  | $\mu \mathrm{S}$ |
| Noise voltage ${ }^{* 3}$ | NV | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=2.0 \mathrm{~V}, \mathrm{R}_{\mathrm{d}}=2.2 \mathrm{k} \Omega \pm 1 \% \\ & \mathrm{C}_{\mathrm{O}}=5 \mathrm{pF}, \text { A-curve } \end{aligned}$ |  |  | 10 | $\mu \mathrm{V}$ |
| Voltage gain | $\mathrm{G}_{\mathrm{V} 1}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=2.0 \mathrm{~V}, \mathrm{R}_{\mathrm{d}}=2.2 \mathrm{k} \Omega \pm 1 \% \\ & \mathrm{C}_{\mathrm{O}}=5 \mathrm{pF}, \mathrm{e}_{\mathrm{G}}=10 \mathrm{mV}, \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ | -5.0 | -1.0 |  | dB |
|  | $\mathrm{G}_{\mathrm{V} 2}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=12 \mathrm{~V}, \mathrm{R}_{\mathrm{d}}=2.2 \mathrm{k} \Omega \pm 1 \% \\ & \mathrm{C}_{\mathrm{O}}=5 \mathrm{pF}, \mathrm{e}_{\mathrm{G}}=10 \mathrm{mV}, \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ | -3.0 | 3.0 |  |  |
|  | $\mathrm{G}_{\mathrm{V} 3}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=1.5 \mathrm{~V}, \mathrm{R}_{\mathrm{d}}=2.2 \mathrm{k} \Omega \pm 1 \% \\ & \mathrm{C}_{\mathrm{O}}=5 \mathrm{pF}, \mathrm{e}_{\mathrm{G}}=10 \mathrm{mV}, \mathrm{f}=1 \mathrm{kHz} \end{aligned}$ | -7.0 | -1.5 |  |  |
| Voltage gain difference | $\Delta\left\|\mathrm{G}_{\mathrm{V}} . \mathrm{f}\right\|^{* 4}$ | $\begin{aligned} & \mathrm{V}_{\mathrm{D}}=2.0 \mathrm{~V}, \mathrm{R}_{\mathrm{d}}=2.2 \mathrm{k} \Omega \pm 1 \% \\ & \mathrm{C}_{\mathrm{O}}=5 \mathrm{pF}, \mathrm{e}_{\mathrm{G}}=10 \mathrm{mV} \\ & \mathrm{f}=1 \mathrm{kHz} \text { to } 70 \mathrm{~Hz} \end{aligned}$ | 0 |  | 1.7 |  |
|  | $\left\|\mathrm{G}_{\mathrm{V} 1}-\mathrm{G}_{\mathrm{V} 3}\right\|$ |  |  | 0.5 | 2.0 | dB |

[^0]2. A protection diode is built-in between gate and source of transistor. However if forward current flows between gate and source transistor might be damaged. So please be careful not insert reverse.
3. *1: $\mathrm{I}_{\mathrm{D}}$ is assured for $\mathrm{I}_{\mathrm{DSS}}$.
*2. Rank classification

| Rank | T | U |
| :---: | :---: | :---: |
| $\mathrm{I}_{\mathrm{D}}(\mu \mathrm{A})$ | 170 to 325 | 265 to 470 |
| $\mathrm{I}_{\text {DSS }}(\mu \mathrm{A})$ | 180 to 305 | 275 to 450 |

*3: NV is assured for design.
*4: $\Delta\left|\mathrm{G}_{\mathrm{V}} . \mathrm{f}\right|$ is assured for AQL 0.065 . (The measurement method is used by source-grounded circuit.)




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[^0]:    Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

